

IFW

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PATENT  
Attorney Docket No.: A8110C1/T51001



Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

10/19/04  
TOWNSEND and TOWNSEND and CREW LLP

By: [Signature]

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of:

ZHENJIANG CUI et al.

Application No.: 10/730,193

Filed: December 5, 2003

For: GAPFILL PROCESS USING A  
COMBINATION OF SPIN-ON-  
GLASS DEPOSITION AND  
CHEMICAL VAPOR  
DEPOSITION TECHNIQUES

Confirmation No. 8868

Examiner: Alexander G. Ghyka

Technology Center/Art Unit: 2812

RESPONSE

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed July 26, 2004, please enter the following amendments and remarks:

**Remarks/Arguments** begin on page 2 of this paper.